Datasheet	Created Date	Document No.	Document Retention	Security		Author
	2017-04-10		Permanent	■ Non-Confidential/ □ Confidential		C.H. Seok
Department	RN2 Research Institute		Reference		Receiver	

RN.2 Technologies

Datasheet

RCP1850Q03N

Rev. 1.2

Release Date 2021-04-02

.

Copyright © 2021 RN2 Technologies Co., Ltd. All Rights Reserved.

Revision History

Rev	Release Date	Description	Author
1.0	2017-04-10	• Initial release	C.H. Seok
1.1	2019-08-28	• Frequency extension modified	M.S. Byun
1.2	2021-04-02	• Input error Modify	G.H. Baek

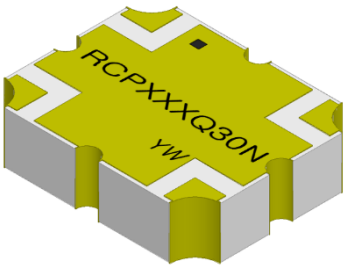
RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

3dB, 90°, Hybrid Coupler
with High-Power Capacity and Stable Performance based on RN2 LTCC Multilayer Technology
Model Name: RCP1850Q03N

KEY FEATURES

- Excellent high-power capacity up to average 180 watts
- Excellent stable performance at different temperatures
- Low insertion loss based on a LTCC base (Er = 5.95), high conductivity metal conductor (Ag), and gold (Au) plating
- Surface mount type
- RoHS compliance (Pb-Free)



APPLICATIONS

- Applications using GSM, UMTS, and LTE
- RF amplifiers
- Communications equipment

GENERAL DESCRIPTIONS

The RCP1850Q03N is a 3dB, 90° hybrid coupler with high-power capacity and stable performance in different temperatures. The LTCC, high conductivity metal conductor (Ag), and gold (Au) plating enable the RCP1850Q03N to minimize insertion loss and improve durability for thermal stabilization and electricity.

The RCP1850Q03N is suited for applications using GSM, UMTS, and LTE and communications equipment, requiring low insertion loss and high power.

The RCP1850Q03N supports up to average 180 watts. It is a SMD type product enabling Pb-Free solder and meets RoHS-6.

ELECTRICAL SPECIFICATIONS

Frequency (MHz)	Amplitude Balance Max.(dB)	Insertion Loss Max.(dB)	Return Loss Min.(dB)
1700 - 2000	± 0.22	0.15	23
2000 - 2200	± 0.30	0.30	20
Isolation Min.(dB)	**Phase Balance (Degree)**	**Power Capacity Avg.(Watt)**	**Operating Temperature(℃)**
23	90 ± 3.0	180	-55 ~ 125
20	90 ± 4.0	180	-55 ~ 125

NOTE: These electrical specifications are measured by using a RN2 test board.
Specifications subject to change without notice.

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

Contents

KEY FEATURES **3**
APPLICATIONS **3**
GENERAL DESCRIPTIONS **3**
ELECTRICAL SPECIFICATIONS **3**
PORT CONFIGURATIONS **5**
MECHANICAL SPECIFICATIONS **5**
POWER DERATING CURVE **6**
RF PERFORMANCE CURVES: Return Loss (-55 ºC, 25 ºC, and 125 ºC) **7**
RF PERFORMANCE CURVES: Coupling and Transmission, Insertion Loss, Isolation, and Phase Balance (-55 ºC, 25 ºC, and 125 ºC) **8**
RF TEST METHODS **9**
RF TEST PROCEDURES 9
RN2 TEST BOARD LAYOUT 12
AUTOMATIC PORT EXTENSIONS (APE) FUNCTION 12
RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN **13**
SOLDERING PROCESS **14**
REFLOW PROFILE **15**
PACKAGING AND ORDERING INFORMATION **16**
CAUTION **17**
LEGAL INFORMATION **18**

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

PORT CONFIGURATIONS

Figure 1 shows the locations of the RCP1850Q03N ports. The orientation marker is included to represent port 1.

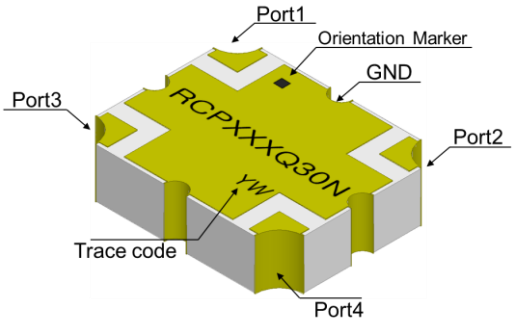


Figure 1. RCP1850Q03N (Top View)

Table 1 describes the RCP1850Q03N port configurations depending on how input signals are split. The Case 1, Case 2, Case 3, and Case 4 configurations mean that one input signal is split into two output signals. When port 1 is defined, the other ports are defined automatically.

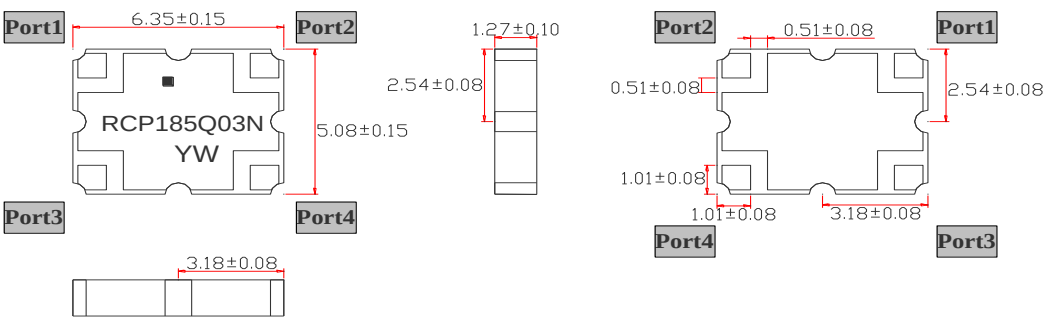
Table 1. RCP1850Q03N Port Configurations

Configuration	Port 1	Port 2	Port 3	Port 4
Case 1.	Input	Isolated	Coupling -3dB, *0˚	Output -3dB, -90˚
Case 2.	Isolated	Input	Output -3dB, -90˚	Coupling -3dB, *0˚
Case 3.	Coupling -3dB, *0˚	Output -3dB, -90˚	Input	Isolated
Case 4.	Output -3dB, -90˚	Coupling -3dB, *0˚	Isolated	Input

***NOTE**: 0˚ is an actual phase or amplitude of the frequency specified at all ports.

MECHANICAL SPECIFICATIONS

Top View **Bottom View**



- Unit : mm
- Weight: 0.14 grams
- Camber specifications: Less than 0.08 mm

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

POWER DERATING CURVE

Figure 2 shows the maximum allowable average power (Maximum input power, CW) of the RCP1850Q03N depending on base PCB temperature changes. The maximum allowable average power of the RCP1850Q03N is limited by the following power derating curve.

The RCP1850Q03N factors that determine the power derating curve are as follows:

- Internal circuit
- Thickness
- Thermal conductivity of materials
- Insertion loss
- Operating temperature
- Mounting interface temperature between the RCP1850Q03N and the base PCB

The maximum operating temperature of the RCP1850Q03N is 125 ºC. Therefore, when the base PCB temperature is over 125 ºC, the RCP1850Q03N operates stably by decreasing its durable average input power. When the base PCB temperature reaches 200 ºC, the maximum allowable average power decreases to 0 watt.

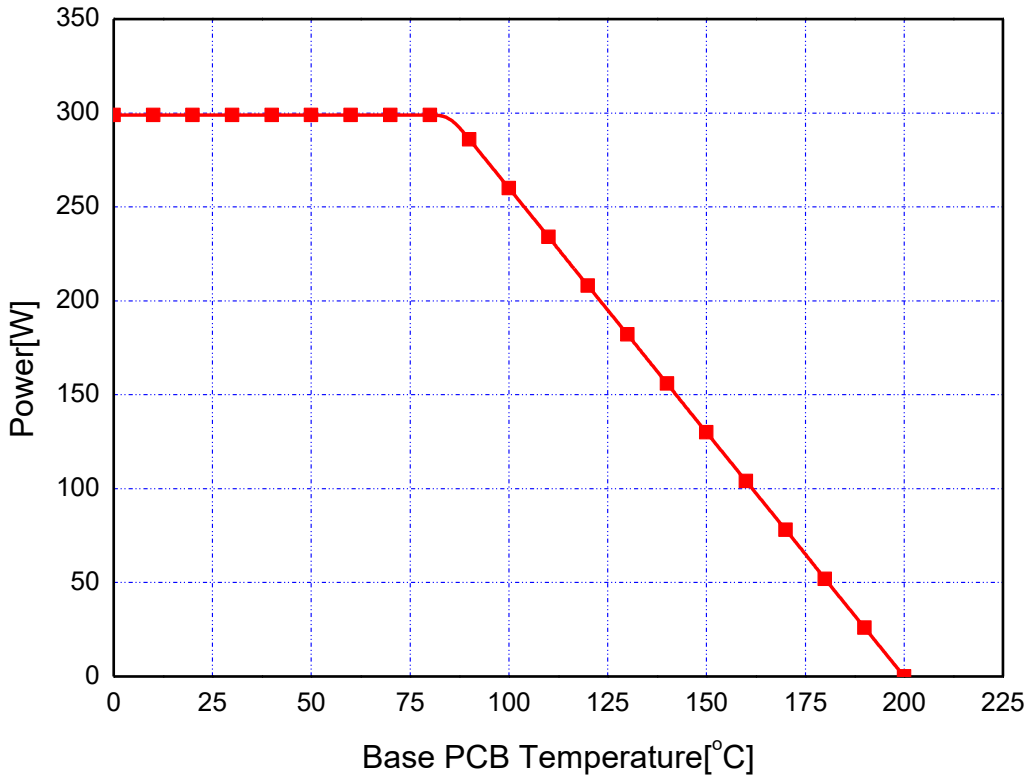


Figure 2. Power Derating Curve

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

RF PERFORMANCE CURVES: Return Loss (-55 ºC, 25 ºC, and 125 ºC)

Figure 3 shows the test plots of the return loss for the RCP1850Q03N. There are few variations for the specified frequencies and temperatures.

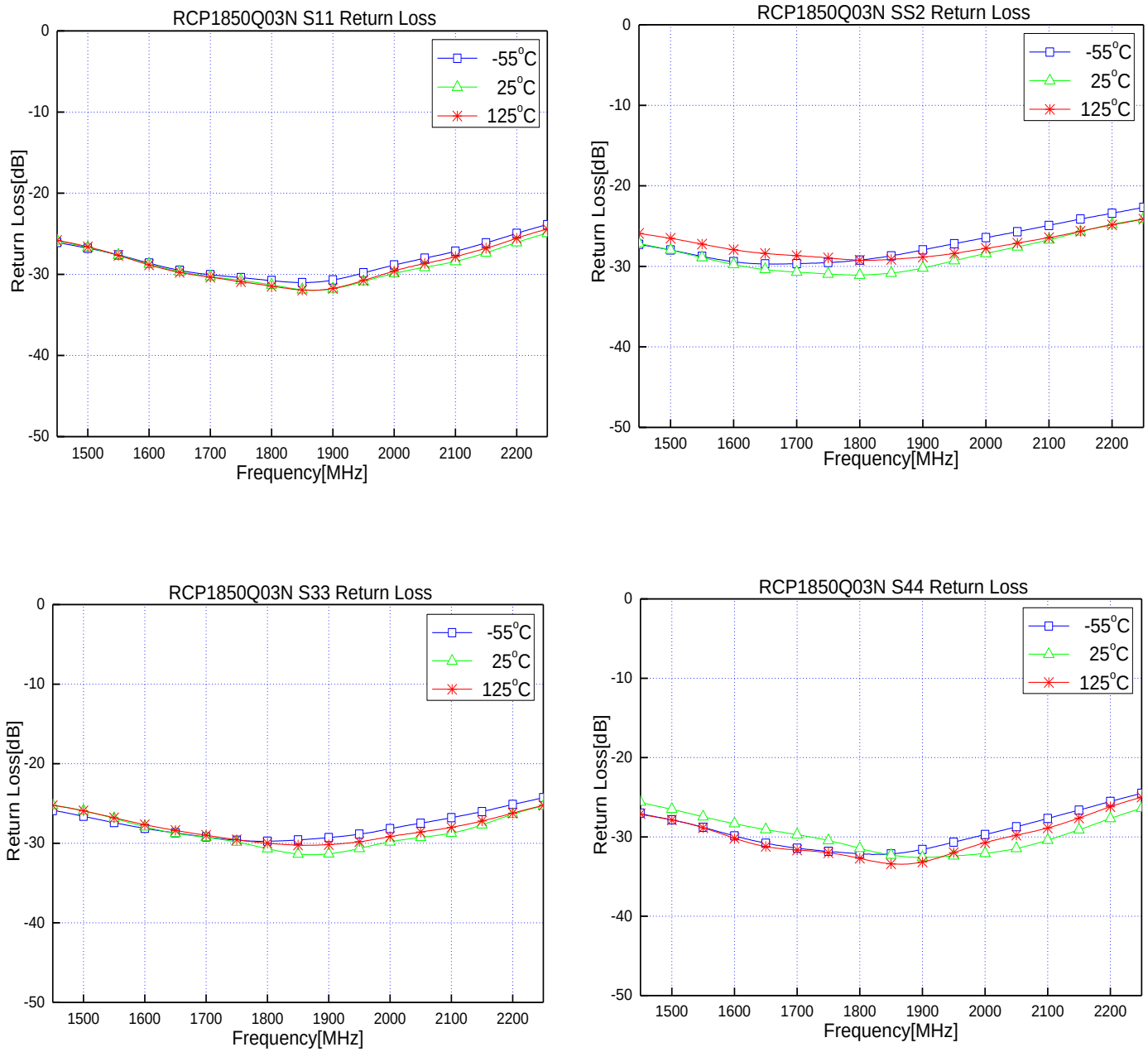


Figure 3. Test Plots of Return Loss (-55 ºC, 25 ºC, and 125 ºC)

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

RF PERFORMANCE CURVES: Coupling and Transmission, Insertion Loss, Isolation, and Phase Balance (-55 ºC, 25 ºC, and 125 ºC)

Figure 4 shows the test plots of the coupling and transmission loss, insertion loss, isolation, and phase balance for the RCP1850Q03N. There are few variations for the specified frequencies and temperatures. These test plots result from the Case 1 configuration in *'Table 1. RCP1850Q03N Port Configurations'*. See *'PORT CONFIGURATIONS'* for more details.

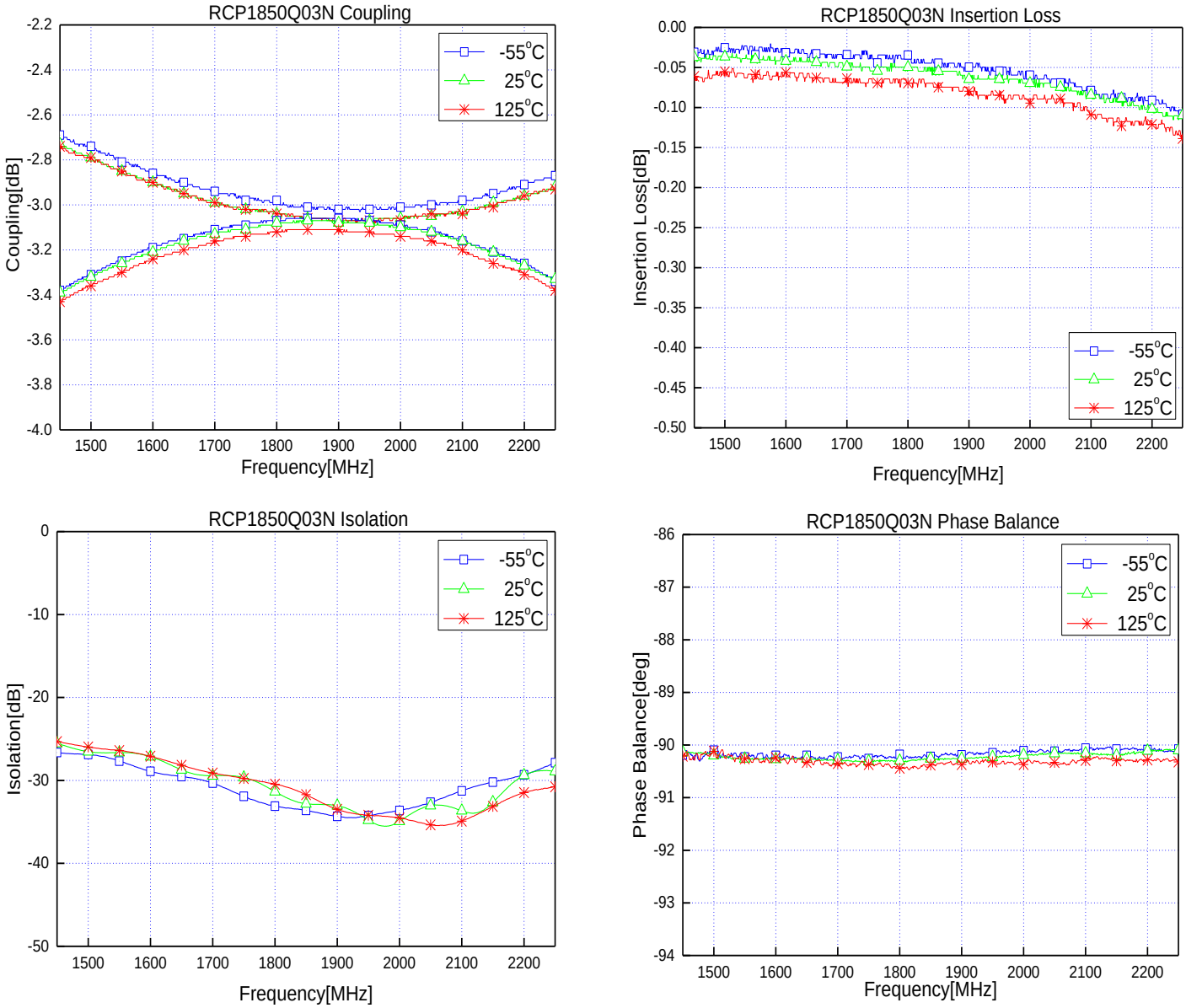


Figure 4. Test Plots of Coupling and Transmission Loss, Insertion Loss, Isolation, and Phase Balance (-55 ºC, 25 ºC, and 125 ºC)

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

RF TEST METHODS

This section describes how to test the RCP1850Q03N RF performance. To ensure s-parameters reliability, we follow our internal test procedures by using the RN2 bare test board, RN2 test board, Vector network analyzer, and test fixture. In addition, we use the Automatic Port Extensions (APE) function of the Vector network analyzer to obtain accurate s-parameters.

Check the following sections for more details:

- RF TEST PROCEDURES
- RN2 TEST BOARD LAYOUT
- AUTOMATIC PORT EXTENSIONS (APE) FUNCTION

RF TEST PROCEDURES

To test the RCP1850Q03N RF performance, we perform the following steps:

1. Preparing the Test Equipment
2. Performing the Automatic Port Extensions (APE) Function of the Vector Network Analyzer
3. Measuring the S-parameters (Coupling, Transmission Loss, Isolation, and Return Loss)
4. Obtaining the Characteristic Parameters (Amplitude Balance, Isolation, Insertion Loss, Return Loss, and Phase Balance)

STEP 1: Preparing the Test Equipment

The following test equipment is prepared to test the RCP1850Q03N RF performance.

- RN2 bare test board
- RN2 test board
- Vector network analyzer
- Test fixture

NOTE: See *'RN2 TEST BOARD LAYOUT'* for the RN2 test board details.

STEP 2: Performing the Automatic Port Extensions (APE) Function of the Vector Network Analyzer

The APE function is used with the RN2 bare test board to correctly check the RCP1850Q03N RF performance. This reduces or eliminates both electrical delay and insertion loss of the test fixture.

The detailed steps are as follows:

1. Place the RN2 bare test board on the test fixture.
2. Click the **Cal** button of the Vector network analyzer to calibrate it.
3. Connect the four ports of the test fixture into the four ports of the Vector network analyzer.
4. Click the **Port Extensions** button of the Vector network analyzer to measure the data of the RN2 bare test board.

NOTE: See *'AUTOMATIC PORT EXTENSIONS FUNCTION'* for more details.

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

STEP 3: Measuring the S-parameters (Coupling, Transmission Loss, Isolation, and Return Loss)

After performing the APE function, the RCP1850Q03N s-parameters are measured through the following steps:

1. Place the RN2 test board on the test fixture.
2. Apply pressure to the test fixture using a pneumatic piston.
3. Connect the four ports of the test fixture into the four ports of the Vector network analyzer.
4. Set port1 as Case 1 configuration in *'Table 1. RCP1850Q03N Port Configurations'*.
5. Calibrate the Vector network analyzer.
6. Measure the coupling value from port 1 to port 3 (S31).
7. Measure the transmission loss value from port 1 to port 4 (S41).
8. Measure the isolation value from port 1 to port 2 (S21).
9. Measure the return loss value from port 1 to port 1, port 2 to port 2, port 3 to port 3, and port 4 to port 4 respectively (S11, S22, S33, and S44).

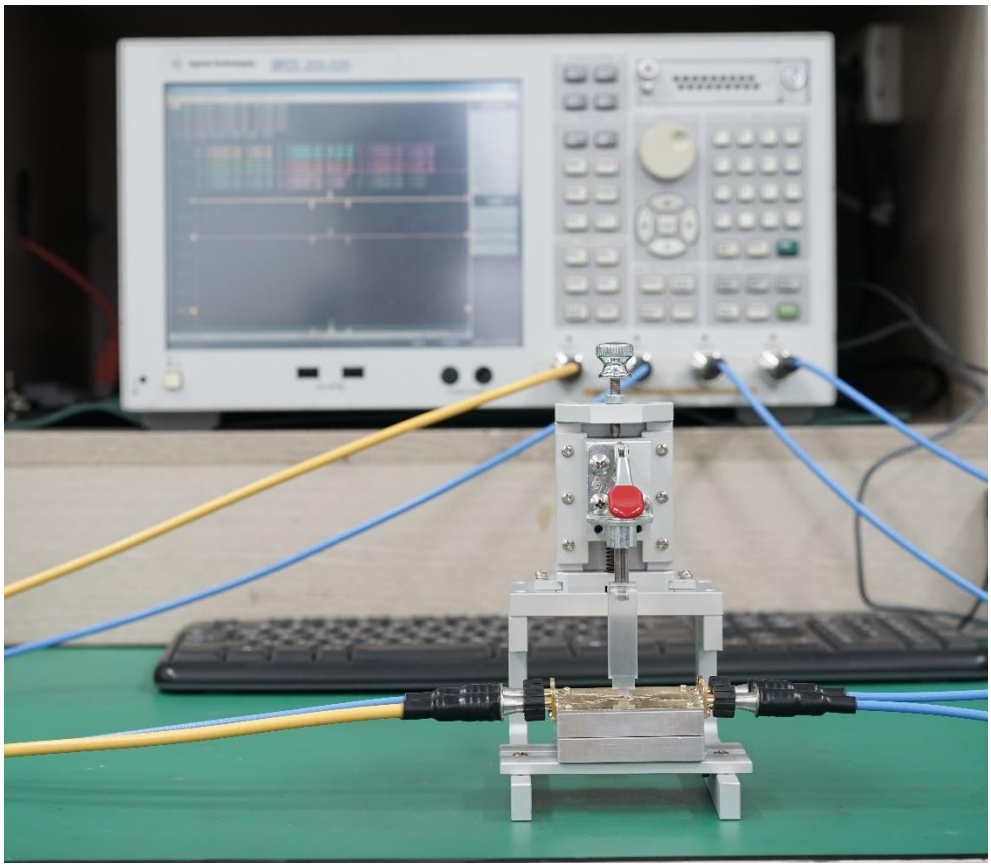


Figure 5. Test Setting to Measure the RCP1850Q03N S-parameters

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

STEP 4: Obtaining the Characteristic Parameters (Amplitude Balance, Isolation, Insertion Loss, Return Loss, and Phase Balance)

The s-parameters are calculated by using the formula in ***Table 2*** to obtain the characteristic parameters, such as amplitude balance, isolation, insertion loss, return loss, and phase balance.

Table 2. Mathematical Formula for the RCP1850Q03N Parameters

Parameter	S-Parameter	Power Method
Coupling	S31	$10 \cdot \log\left(\frac{P_{cou}}{P_{in}}\right)$
Transmission Loss	S41	$10 \cdot \log\left(\frac{P_{out}}{P_{in}}\right)$
Isolation	S21	$10 \cdot \log\left(\frac{P_{iso}}{P_{in}}\right)$
Insertion Loss	-	$10 \cdot \log\left(\frac{P_{in}}{P_{cou} + P_{out}}\right)$
Return Loss	S11 S22 S33 S44	$10 \cdot \log\left(\frac{P_{in}}{P_{back}}\right)$
Amplitude Balance	-	$10 \cdot \log\left(P_{cou} \Big/ \frac{P_{cou} + P_{out}}{2}\right)$
Phase Balance	S41 S31	$\text{Phase}_{(S31)} - \text{Phase}_{(S41)}$

NOTE

- P_{in} : Power of Input Port
- P_{out} : Power of Output Port
- P_{cou} : Power of Coupling Port
- P_{iso} : Power of Isolated Port
- P_{back} : Return Power of Input Port

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

RN2 TEST BOARD LAYOUT

Figure 6 shows the RN2 test board layout used for testing the RCP1850Q03N RF performance. The RN2 test board is based on the Taconic RF35 board with the dielectric constant of 3.5, board thickness of 0.8 mm, and copper of 1 Oz.

We recommend that you use the same material and design layout, as shown in ***Figure 6***, to meet the specifications in this datasheet. However, if you use different materials, you must follow the basic guidelines. See *'RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN'* for more details.

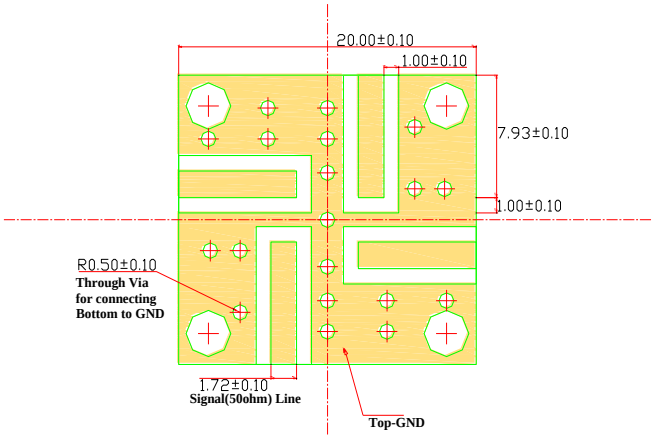


Figure 6. RN2 Test Board Layout

AUTOMATIC PORT EXTENSIONS (APE) FUNCTION

To accurately measure the RCP1850Q03N s-parameters, we use the Automatic Port Extensions (APE) function of the Vector network analyzer. The APE function is used for reducing or eliminating both electrical delay and insertion loss of test fixtures. It provides a convenient, automated way to calculate the insertion loss and electrical delay terms by a simple measurement of an open or short circuit, which is easy to do in test fixtures.

We consider the transmission lines of the RN2 bare test board as extensions of the coaxial test cables that are between the Vector network analyzer and the RCP1850Q03N. With the APE function, we extend the coaxial test ports so that our calibration plane is right at the terminals of the RCP1850Q03N, and not at the connectors of the RN2 bare test board.

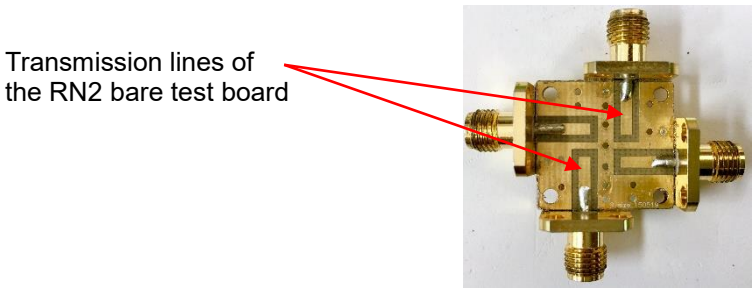


Figure 7. Performing the APE Function Test

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

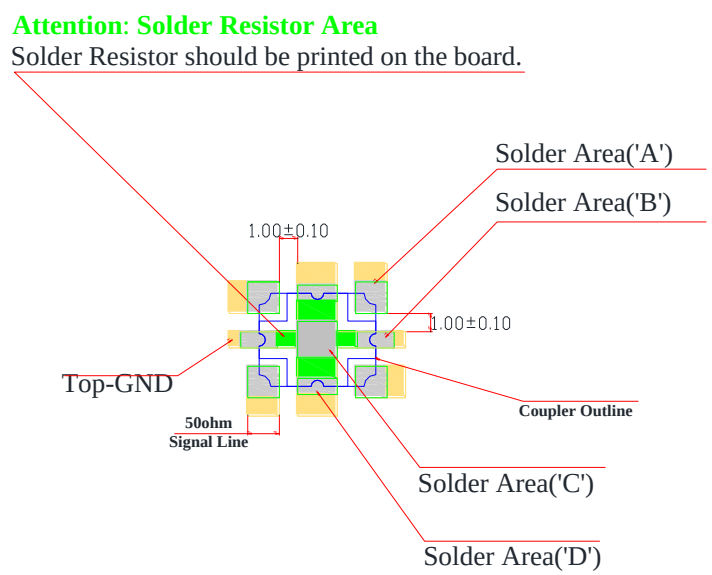
RECOMMENDED PCB LAYOUT AND SOLDER MASK PATTERN

Figure 8 shows the recommended PCB layout and solder mask pattern to meet the specifications in this datasheet. When you use different materials other than the RN2 test board, you must follow the basic guidelines at minimum.

Basic Guidelines

- Place GND more than 30% of the RCP1850Q03N GND dimension regardless of a via size.
- Appropriately increase via sizes and numbers to allow low impedance ground connection and good thermal conductivity.
- Align the RCP1850Q03N ground plane with the solder to have good connection to ground.
- Fill the via holes under the RCP1850Q03N with the solder for thermal emission.

NOTE: Contact the RN2 Technologies sales team for more detailed PCB layout and solder mask pattern information.



NOTE

- Test Solder Cream: SAC-305 (Alpha Metal)
- Pb-Free Solder Alloy: Sn/Ag/Cu Ratio of 96.5/3.0/0.5
- Solder Area ('A') Dimension : 1.72 mm by 1.72 mm
- Solder Area ('B') Dimension : 2.0 mm by 0.88 mm
- Solder Area ('C') Dimension : 2.15 mm by 2.0 mm
- Solder Area ('D') Dimension : 2.15 mm by 0.88 mm

Figure 8. Recommended PCB Layout and Solder Mask Pattern

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

SOLDERING PROCESS

The RCP1850Q03N soldering steps are as follows:

1. Cleaning the PCB
2. Applying solder paste to the PCB
3. Placing the RCP1850Q03N on the PCB
4. Reflowing the RCP1850Q03N to the PCB
5. Cleaning and inspecting the soldered PCB with the RCP1850Q03N

STEP 1: Cleaning the PCB
Carefully clean the PCB surface where the RCP1850Q03N is soldered.
Particles must not be placed on the PCB surface where the RCP1850Q03N is soldered.

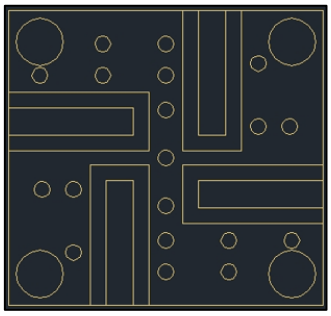


Figure 9. Cleaning the PCB Surface Where the RCP1850Q03N is Soldered

STEP 2: Applying the Solder Paste to the PCB
Apply the solder paste to the 9 points on the PCB surface.
It enables good thermal conductivity because the RCP1850Q03N is firmly attached to the PCB surface without air.

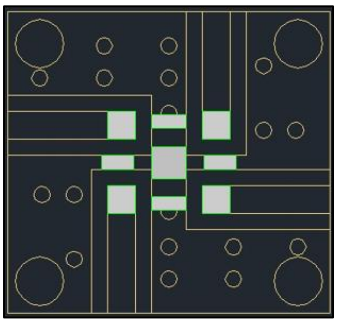


Figure 10. Applying the Solder Paste to the 9 Points on the PCB Surface

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

STEP 3: Placing the RCP1850Q03N on the PCB
Correctly place the RCP1850Q03N on the 9 points of the PCB surface.
Applying the solder paste to the 9 points helps you firmly attach the RCP1850Q03N to the PCB surface.

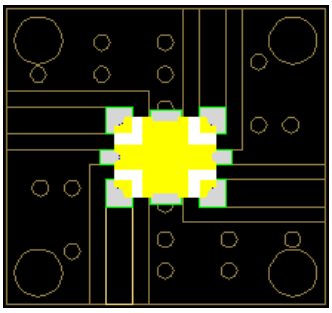


Figure 11. Placing the RCP1850Q03N on the 9 Points of the PCB Surface

STEP 4: Reflowing the RCP1850Q03N to the PCB
We recommend both manual soldering and PCB surface pre-heating methods when reflowing the RCP1850Q03N to the PCB surface. Be careful NOT to touch the iron tip to the RCP1850Q03N when you use the manual soldering method.
See *'REFLOW PROFILE'* for more details.

REFLOW PROFILE

Figure 12 shows the thermal reflow profile of the SAC-305 (Alpha metal), which is a test solder cream we used.

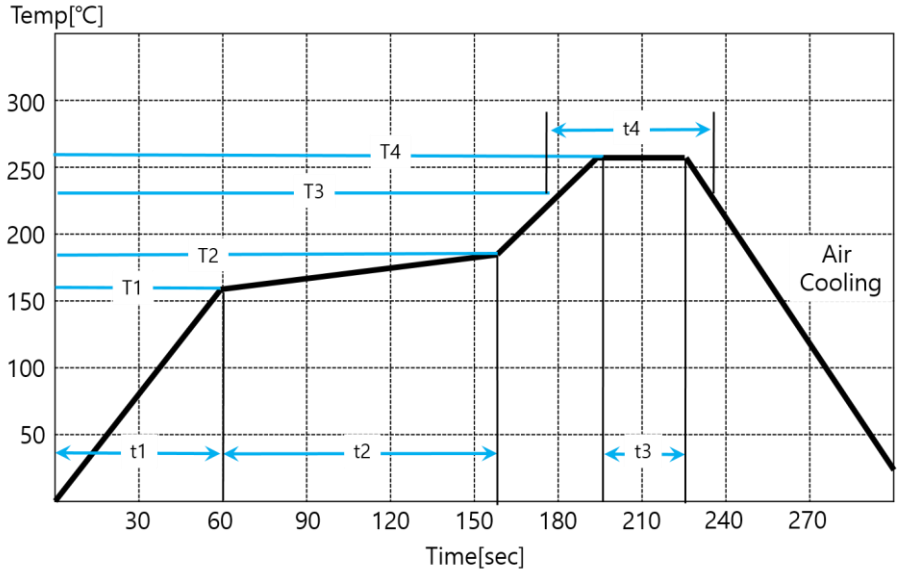
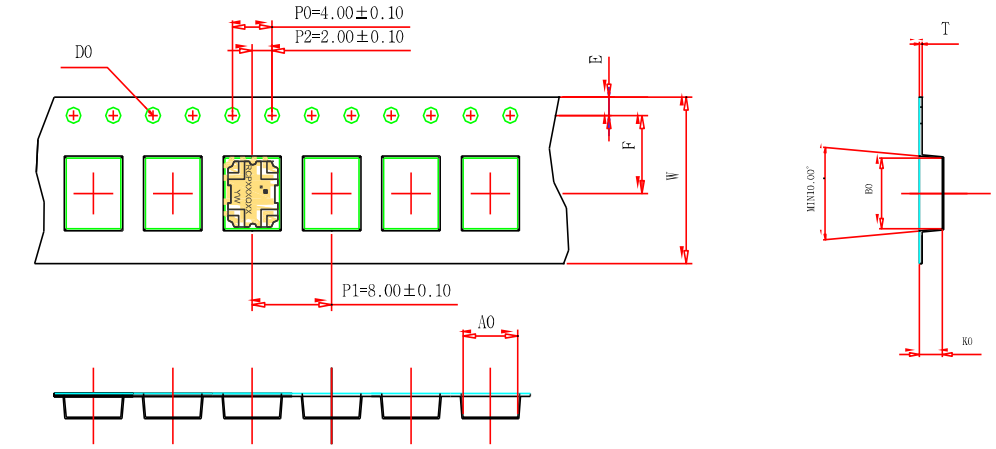


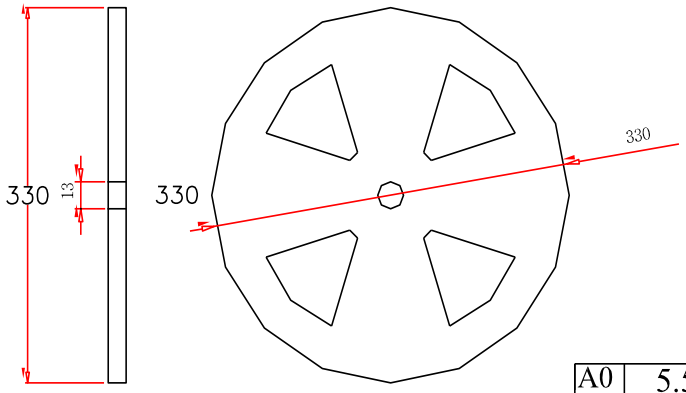
Figure 12. Thermal Reflow Profile

	Ramp Up	Pre-Heating	Peak	Soaking
Temperature(℃)	T1:160±5℃	T2:180±5℃	T4:260±5℃	T3:230±5℃
Time(sec)	t1:60±5sec	t2:100±15sec	t3:30±5sec	t4:60±10sec

RN.2 Technologies
The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

PACKAGING AND ORDERING INFORMATION





Units : mm

A0	5.50±0.10	E	1.75±0.10
B0	6.80±0.10	F	7.50±0.10
D0	1.55±0.05	T	0.30±0.05
K0	1.87±0.10	W	16.00±0.30

Standard Packaging Quantity : 4,000 PCS / Reel

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

CAUTION

PLEASE READ THIS NOTICE BEFORE USING OUR LTCC COUPLERS.

I. Be careful when transporting

- Ensure proper transportation as excessive stress or shock may damage LTCC couplers due to the nature of ceramics structure.
- LTCC couplers cracked or damaged on terminals may have their property changed.

II. Be careful during storage

- Store LTCC couplers in the temperature of -55℃ to +125℃.
- Keep the humidity at 45% to 75% around LTCC couplers.
- Prevent corrosive gas (Cl_2, NH_3, SO_X, NO_X, etc.) from contacting LTCC couplers.
- It is recommended to use LTCC couplers within 6 months of receipt. If the period exceeds 6 months, solderability may need to be verified.

III. Be careful when soldering

- Solder all the ground terminals, IN and OUT pad of LTCC couplers on the ground plane of the PCB.
- LTCC couplers may be cracked or broken by uneven forces from a claw or suction device.
- Mechanical stress by any other devices may damage LTCC couplers when positioning them on PCB.
- Do not use dropped LTCC couplers.
- Ensure that any soldering is carried out by the condition of specification sheet.
- Do not re-use LTCC couplers which are de-soldered from PCB.

RN.2 Technologies

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.

LEGAL INFORMATION

Information in this document is believed to be accurate and reliable. However, RN2 Technologies does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. RN2 Technologies does not take any responsibility for the content in this document if provided by an information source outside of RN2 Technologies.

RN2 Technologies reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

RN2 Technologies products are not authorized for use in safety-critical applications (such as life support) where a failure of the RN2 Technologies products would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of RN2 Technologies products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by RN2 Technologies. Further, Buyers must fully indemnify RN2 Technologies and its representatives against any damages arising out of the use of RN2 Technologies products in such safety-critical applications.

RN2 Technologies does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products. Customer is responsible for doing all necessary testing for the customer's applications or products using RN2 Technologies products in order to avoid a default of the applications and the products. RN2 Technologies does not accept any liability in this respect.

RN2 Technologies

For more information, refer to:

HTTP://WWW.RN2.CO.KR

The information of this document is the exclusive property of RN2 Technologies and shall be kept confidential. Do not disclose, reproduce, or distribute this information without prior written permission of RN2 Technologies.